



(11) **EP 1 608 007 B8**

(12) **CORRECTED EUROPEAN PATENT SPECIFICATION**

(15) Correction information:
Corrected version no 1 (W1 B1)
Corrections, see
Bibliography INID code(s) 73

(51) Int Cl.:
H01L 21/316 ^(2006.01) **H01L 21/318** ^(2006.01)
C23C 16/56 ^(2006.01) **C23C 16/455** ^(2006.01)
H01L 21/3105 ^(2006.01) **H01L 21/314** ^(2006.01)
H01L 29/51 ^(2006.01) **H01L 21/28** ^(2006.01)

(48) Corrigendum issued on:
26.09.2012 Bulletin 2012/39

(86) International application number:
PCT/JP2004/003638

(45) Date of publication and mention
of the grant of the patent:
15.08.2012 Bulletin 2012/33

(87) International publication number:
WO 2004/086485 (07.10.2004 Gazette 2004/41)

(21) Application number: **04721668.4**

(22) Date of filing: **18.03.2004**

(54) **METHOD FOR FORMING INSULATING FILM IN SEMICONDUCTOR DEVICE**

VERFAHREN ZUR BILDUNG EINES ISOLATIONSFILMS IN EINEM HALBLEITERBAUELEMENT
PROCEDE DE FORMATION DE FILM ISOLANT DANS UN DISPOSITIF SEMICONDUCTEUR

(84) Designated Contracting States:
BE DE FI FR

(30) Priority: **24.03.2003 JP 2003079279**

(43) Date of publication of application:
21.12.2005 Bulletin 2005/51

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